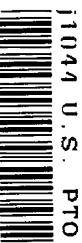


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A

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JC872 U.S. PTO
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James C. Simmons

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Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

Enclosed for filing is the non-provisional CIP patent application of Hooshang Heshmat, Erik E. Swanson, Dennis H. Locke, and James F. Walton II for HYBRID FOIL- MAGNETIC BEARING WITH IMPROVED LOAD SHARING, along with the Declaration and filing fee (calculated as discussed below).

Also enclosed is an assignment thereof to Mohawk Innovative Technology, Inc., along with the cover sheet and fee (check for \$40) for recording thereof.

Also enclosed is a Nonpublication Request.

Applicant claims small entity status (37 CFR 1.27). The application contains 22 total claims and 4 independent claims, i.e., an excess of 1 independent claim and 2 total claims. The filing fee, at the small entity rate, is thus the basic fee of \$370 plus an excess claims fee of \$60, or \$430. Enclosed is a check for the filing fee of \$430.

Respectfully submitted,
James C. Simmons
James C. Simmons
Reg. no. 28,474

Enclosures

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number.

**NONPUBLICATION REQUEST
UNDER
35 U.S.C. 122(b)(2)(B)(i)**

First Named Inventor

Hooshang Heshmat

Title

HYBRID FOIL-MAGNETIC
BEARING WITH IMPROVED LOAD SHARING

Atty Docket Number

MI 703 USN - CIP

I hereby certify that the invention disclosed in the attached application **has not and will not** be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing.

I hereby request that the attached application not be published under 35 U.S.C. 122(b).

Dec. 13, 2001

Date

James C. Simmons

Signature

JAMES C. SIMMONS

Typed or printed name

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant **must** notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. **Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).**

Burden Hour Statement: This collection of information is required by 37 CFR 1.213(a). The information is used by the public to request that an application not be published under 35 U.S.C. 122(b) (and the PTO to process that request). Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This form is estimated to take 6 minutes to complete. This time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Assistant Commissioner for Patents, Washington, DC 20231.